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FLH Ref. No.: 450100-04736

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To the Honorable Commissioner of Patents and Trademarks	: Please 163.139622	aments or copy thereof.
Name of conveying party      Masaru MIYAMOTO      Additional name(s) of conveying party(ies)     attached? YesX_ No	2. Name and address of receiving party(ies)  SONY CORPORATION 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 141-0001, Japan	
3. Nature of conveyance:  X Assignment Security Agreement Merger Change of Name Other Execution Date(s): May 30, 2005	Additional name(s) & address	r ⊅
<ol> <li>Application number(s) or patent number(s):         If this document is being filed together with a new application, the exect A. Patent Application No. 10/524,994.     </li> <li>Additional numbers attached? Yes X_ No</li> </ol>	cution date of the application is:	THE SECTION S. A. SECOND S. A.
<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> </ol>	6. Total number of applications a	and patents involved $\frac{1}{2}$
Name: WILLIAM S. FROMMER Internal Address: FROMMER LAWRENCE & HAUG LLP Street Address: 745 FIFTH AVENUE City: NEW YORK State: NY Zip: 10151	7. Total fee (37 CFR 3.41)  X Enclosed  Authorized to be charged	\$ 40.00 to deposit account 50-0320
	8. Deposit account number: (Attach duplicate copy of this	page if paying by deposit account)
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9. Statement and signature.  To the best of my knowledge and belief, the foregoing information is tr  Thomas F. Presson, Reg. No. 41,442  Name of Person Signing  Sig	rue and correct and any attached copy	December 16, 2005  Date
		number of pages including cover sheet, nents, and document: 2
Mail documents to be recorded wit  Mail Stop Assignment  Director of the U.S. Pat  P.O. F  Alexandria,	ch this portion th required cover sheet information to nt Recordation Services tent and Trademark Office Box 1450 VA 22313-1450	
Public burden reporting for this sample cover sheet is estimated to average the document and gathering the data needed, and completing and reviewir the U.S. Patent and Trademark Office, Office of Information Systems, P. Budget, Paperwork Reduction Project (0651-0011), Washington, D.C. 2050	ng the sample cover sheet. Send cook K2-1000C, Washington, D.C. 2023	mments regarding this burden estimate to

## ASSIGNMENT

FLH File No.: 450100-04736

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

DIGITAL SIGNAL TRANSMISSION SYSTEM AND METHOD, TRANSMISSION APPARATUS AND METHOD, AND RECEPTION APPARATUS AND METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1,00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuncration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment end sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: International Serial Number: PCT/IP03/10546, International Filing Date; August 21, 2003,

This assignment executed on the dates indicated below.

Masaru MIYAMOTO	
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of First or sole inventor  Prasaru Pringamoto  Signature of first or sole inventor	May 30, 2005
Signature of first or sole inventor	Date of this assignment
Name of second inventor	Execution date of U.S. Patent Application
Residence of second inventor	
Signature of second inventor	Date of this assignment

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PATENT REEL: 017315 FRAME: 0500